## **Board Stack Report**

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Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1 1		Top Paste			•
2		Top Overlay			
3		Top Solder	Solder Resist	0,025mm 3,5 0,036mm	
4		Top Layer	Copper		
5		Dielectric 1	FR-4	1,524mm	4,6
6		Bottom Layer	Copper	0,036mm	
7		Bottom Solder	Solder Resist	0,025mm 3,5	
8		Bottom Overlay			
9 '		Bottom Paste			
Height: 1,646mm					